Justin Bogan

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34 375 12 18 g-index

40 452 4.1 3.33 ext. papers ext. citations avg, IF L-index

#	Paper	IF	Citations
34	Exploring the Role of Adsorption and Surface State on the Hydrophobicity of Rare Earth Oxides. <i>ACS Applied Materials & Discrete States and Surfaces, 2017</i> , 9, 13751-13760	9.5	46
33	Interdiffusion and barrier layer formation in thermally evaporated Mn/Cu heterostructures on SiO2 substrates. <i>Applied Physics Letters</i> , 2011 , 98, 123112	3.4	34
32	A new method for assessing the recyclability of powders within Powder Bed Fusion process. <i>Materials Characterization</i> , 2020 , 161, 110167	3.9	30
31	Chemical and structural investigation of the role of both Mn and Mn oxide in the formation of manganese silicate barrier layers on SiO2. <i>Journal of Applied Physics</i> , 2011 , 110, 054507	2.5	28
30	Synchrotron radiation photoemission study of in situ manganese silicate formation on SiO2 for barrier layer applications. <i>Applied Physics Letters</i> , 2011 , 98, 113508	3.4	26
29	In Situ XPS Chemical Analysis of MnSiO3 Copper Diffusion Barrier Layer Formation and Simultaneous Fabrication of Metal Oxide Semiconductor Electrical Test MOS Structures. <i>ACS Applied Materials & Discourse (Materials & Discourse)</i> 1, 2470-7	9.5	24
28	On the use of (3-trimethoxysilylpropyl)diethylenetriamine self-assembled monolayers as seed layers for the growth of Mn based copper diffusion barrier layers. <i>Applied Surface Science</i> , 2018 , 427, 260-266	6.7	18
27	Photoemission study of the identification of Mn silicate barrier formation on carbon containing low-Idielectrics. <i>Microelectronic Engineering</i> , 2014 , 130, 46-51	2.5	17
26	Scanning transmission electron microscopy investigations of self-forming diffusion barrier formation in Cu(Mn) alloys on SiO2. <i>APL Materials</i> , 2013 , 1, 042105	5.7	15
25	Photoemission study of carbon depletion from ultralow-larbon doped oxide surfaces during the growth of Mn silicate barrier layers. <i>Journal of Applied Physics</i> , 2011 , 110, 124512	2.5	13
24	Chemical and structural investigations of the interactions of Cu with MnSiO3 diffusion barrier layers. <i>Journal of Applied Physics</i> , 2012 , 112, 064507	2.5	13
23	Area-Selective ALD of Ru on Nanometer-Scale Cu Lines through Dimerization of Amino-Functionalized Alkoxy Silane Passivation Films. <i>ACS Applied Materials & Discrete Amp; Interfaces</i> , 2020 , 12, 4678-4688	9.5	13
22	Nucleation and adhesion of ultra-thin copper films on amino-terminated self-assembled monolayers. <i>Applied Surface Science</i> , 2018 , 462, 38-47	6.7	12
21	Chemical and structural investigations of the incorporation of metal manganese into ruthenium thin films for use as copper diffusion barrier layers. <i>Applied Physics Letters</i> , 2012 , 101, 231603	3.4	9
20	Defect-mediated ferromagnetism in ZnO:Mn nanorods. <i>Applied Physics A: Materials Science and Processing</i> , 2014 , 115, 313-321	2.6	8
19	Hard x-ray photoelectron spectroscopy study of copper formation by metal salt inclusion in a polymer film. <i>Journal Physics D: Applied Physics</i> , 2019 , 52, 435301	3	7
18	In Situ Investigations into the Mechanism of Oxygen Catalysis on Ruthenium/Manganese Surfaces and the Thermodynamic Stability of Ru/Mn-Based Copper Diffusion Barrier Layers. <i>Journal of Physical Chemistry C</i> , 2013 , 117, 16136-16143	3.8	7

LIST OF PUBLICATIONS

17	In-situ surface and interface study of atomic oxygen modified carbon containing porous low- dielectric films for barrier layer applications. <i>Journal of Applied Physics</i> , 2016 , 120, 105305	2.5	7
16	Physical, chemical and electrical characterisation of the diffusion of copper in silicon dioxide and prevention via a CuAl alloy barrier layer system. <i>Materials Science in Semiconductor Processing</i> , 2017 , 63, 227-236	4.3	5
15	The impact of porosity on the formation of manganese based copper diffusion barrier layers on low-Idielectric materials. <i>Journal Physics D: Applied Physics</i> , 2015 , 48, 325102	3	5
14	Oxidation of ruthenium thin films using atomic oxygen. <i>Thin Solid Films</i> , 2015 , 597, 112-116	2.2	5
13	Precise Definition of a "Monolayer Point" in Polymer Brush Films for Fabricating Highly Coherent TiO Thin Films by Vapor-Phase Infiltration. <i>Langmuir</i> , 2020 , 36, 12394-12402	4	5
12	Surface characterization of poly-2-vinylpyridine polymer for area selective deposition techniques. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2019 , 37, 050601	2.9	4
11	The addition of aluminium to ruthenium liner layers for use as copper diffusion barriers. <i>Applied Surface Science</i> , 2014 , 307, 677-681	6.7	4
10	Analysis of Al and Cu salt infiltration into a poly 2-vinylpyridine (P2vP) polymer layer for area selective deposition applications. <i>Journal Physics D: Applied Physics</i> , 2020 , 53, 115105	3	4
9	Investigation of nitrogen incorporation into manganese based copper diffusion barrier layers for future interconnect applications. <i>Surfaces and Interfaces</i> , 2018 , 13, 133-138	4.1	4
8	Nitrogen reactive ion etch processes for the selective removal of poly-(4-vinylpyridine) in block copolymer films. <i>Nanotechnology</i> , 2018 , 29, 355302	3.4	3
7	Investigation of the release of Si from SiO2 during the formation of manganese/ruthenium barrier layers. <i>Applied Physics Letters</i> , 2013 , 102, 201603	3.4	3
6	Controlling wettability of PECVD-deposited dual organosilicon/carboxylic acid films to influence DNA hybridisation assay efficiency. <i>Journal of Materials Chemistry B</i> , 2017 , 5, 8378-8388	7.3	2
5	Chemical and electrical characterisation of the segregation of Al from a CuAl alloy (90%:10% wt) with thermal anneal. <i>Thin Solid Films</i> , 2016 , 599, 59-63	2.2	2
4	The role of atomic oxygen in the decomposition of self-assembled monolayers during area-selective atomic layer deposition. <i>Applied Surface Science</i> , 2022 , 586, 152679	6.7	1
3	A photoemission study of the effectiveness of nickel, manganese, and cobalt based corrosion barriers for silicon photo-anodes during water oxidation. <i>Journal of Applied Physics</i> , 2016 , 119, 195301	2.5	1
2	Synchrotron radiation study of metallic titanium deposited on dielectric substrates. <i>Journal of Vacuum Science and Technology B:Nanotechnology and Microelectronics</i> , 2018 , 36, 040602	1.3	
1	STEM Analysis Of Cu(Mn) Self-Forming Diffusion Barriers on SiO2 For Applications In The Semiconductor Industry. <i>Microscopy and Microanalysis</i> , 2012 , 18, 1842-1843	0.5	